

Table 1.

# **PSMN013-80YS**

N-channel LFPAK 80 V 12.9 m $\Omega$  standard level MOSFET

Rev. 01 — 25 June 2009

**Product data sheet** 

# 1. Product profile

## **1.1 General description**

Standard level N-channel MOSFET in LFPAK package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

## 1.2 Features and benefits

- Advanced TrenchMOS provides low RDSon and low gate charge
- High efficiency gains in switching power converters

## **1.3 Applications**

Quick reference

- DC-to-DC converters
- Lithium-ion battery protection
- Load switching

## 1.4 Quick reference data

- Improved mechanical and thermal characteristics
- LFPAK provides maximum power density in a Power SO8 package
- Motor control
- Server power supplies

	QUICK TETETETICE					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 150 °C	-	-	80	V
I <sub>D</sub>	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V}; \text{ see } \frac{\text{Figure 1}}{10000000000000000000000000000000000$	-	-	60	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	-	106	W
Tj	junction temperature		-55	-	175	°C
Avalanc	he ruggedness					
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; $I_D$ = 55 A; $V_{sup}$ $\leq$ 80 V; $R_{GS}$ = 50 $\Omega$ ; unclamped	-	-	70	mJ
Dynamic	characteristics					
$Q_{GD}$	gate-drain charge	$V_{GS}$ = 10 V; $I_D$ = 25 A; $V_{DS}$ = 40 V; see <u>Figure 14</u> ; see <u>Figure 15</u>	-	8	-	nC
Q <sub>G(tot)</sub>	total gate charge	$V_{GS}$ = 10 V; $I_D$ = 25 A; $V_{DS}$ = 40 V; see <u>Figure 14</u> ; see <u>Figure 15</u>	-	37	-	nC
Static ch	aracteristics					
R <sub>DSon</sub>	drain-source on-state	$V_{GS}$ = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 100 °C; see <u>Figure 12</u>	-	-	19.8	mΩ
	resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 25 °C; see <u>Figure 13</u>	-	9.7	12.9	mΩ

# nexperia

# 2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source		-
2	S	source	mb	
3	S	source		
4	G	gate	0	
mb	D	mounting base; connected to drain	$\begin{array}{c} \hline \\ 1 \\ 2 \\ 3 \\ 4 \end{array}$	mbb076 S
			SOT669 (LFPAK)	

# 3. Ordering information

Table 3. Ordering information							
Type number Package							
	Name	Description	Version				
PSMN013-80YS	LFPAK	plastic single-ended surface-mounted package (LFPAK); 4 leads	SOT669				

# 4. Limiting values

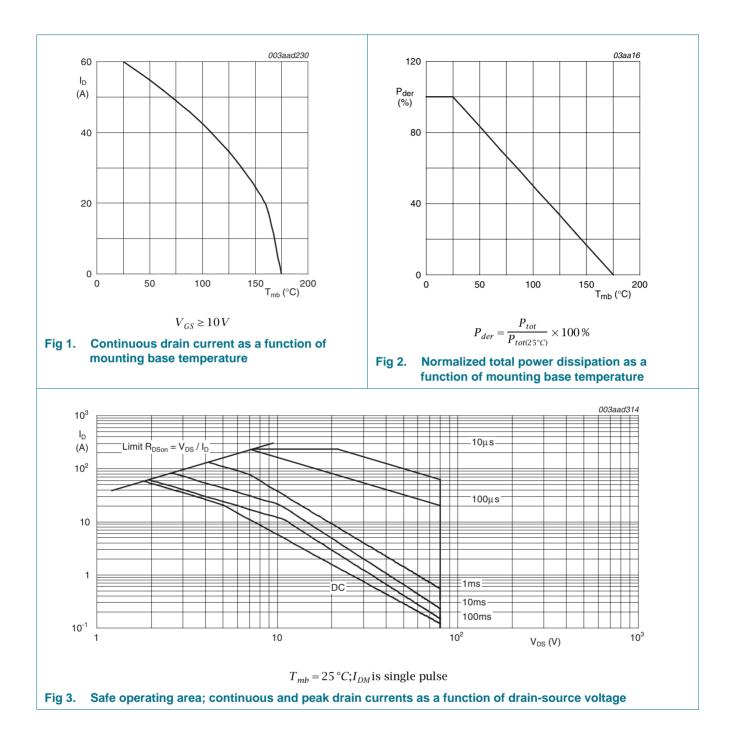
#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

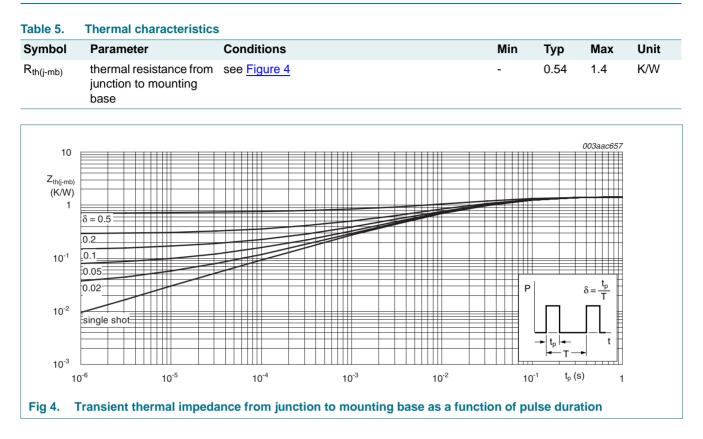
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 150 °C	-	80	V
V <sub>DGR</sub>	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 150 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$	-	80	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
I <sub>D</sub>	drain current	$V_{GS}$ = 10 V; $T_{mb}$ = 100 °C; see <u>Figure 1</u>	-	42	А
		$V_{GS}$ = 10 V; $T_{mb}$ = 25 °C; see <u>Figure 1</u>	-	60	А
I <sub>DM</sub>	peak drain current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$ ; see Figure 3	-	233	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	106	W
T <sub>stg</sub>	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
T <sub>sld(M)</sub>	peak soldering temperature		-	260	°C
Source-dr	ain diode				
I <sub>S</sub>	source current	T <sub>mb</sub> = 25 °C	-	60	А
I <sub>SM</sub>	peak source current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$	-	233	А
Avalanche	ruggedness				
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; $I_{D}$ = 55 A; $V_{sup}$ $\leq$ 80 V; $R_{GS}$ = 50 $\Omega;$ unclamped	-	70	mJ

# **PSMN013-80YS**

#### N-channel LFPAK 80 V 12.9 mΩ standard level MOSFET



# 5. Thermal characteristics



# 6. Characteristics

#### Table 6. Characteristics

Tested to JEDEC standards where applicable.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V <sub>(BR)DSS</sub>	drain-source	I <sub>D</sub> = 250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = -55 °C	73	-	-	V
	breakdown voltage	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^{\circ}C$	80	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C}; \text{ see}$ Figure 10; see Figure 11	1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C}; \text{ see}$ Figure 10; see Figure 11	-	-	4.6	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}; \text{ see}$ Figure 10; see Figure 11	2	3	4	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	3	μA
		$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$	-	-	40	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	100	nA
		$V_{GS}$ = 20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 175 °C; see <u>Figure 12</u>	-	-	31	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 100 °C; see <u>Figure 12</u>	-	-	19.8	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 25 °C; see <u>Figure 13</u>	-	9.7	12.9	mΩ
R <sub>G</sub>	internal gate resistance (AC)	f = 1 MHz	-	0.68	-	Ω
Dynamic of	characteristics					
Q <sub>G(tot)</sub>	total gate charge	$I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V}$	-	31	-	nC
		$I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V}; \text{ see}$ Figure 14; see Figure 15	-	37	-	nC
Q <sub>GS</sub>	gate-source charge	$I_D$ = 25 A; $V_{DS}$ = 40 V; $V_{GS}$ = 10 V; see	-	11	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate-source charge	Figure 14; see Figure 15	-	7	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate-source charge		-	4	-	nC
Q <sub>GD</sub>	gate-drain charge		-	8	-	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	$I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}$	-	4.8	-	V
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 40 V; V <sub>GS</sub> = 0 V; f = 1 MHz;	-	2420	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C; see <u>Figure 16</u>	-	224	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	125	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = 40 V; $R_{L}$ = 1.6 Ω; $V_{GS}$ = 10 V;	-	20	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 4.7 \ \Omega$	-	15	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	37	-	ns
t <sub>f</sub>	fall time		-	10	-	ns

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Symbol

Source-drain diode

Max

Unit

### N-channel LFPAK 80 V 12.9 mΩ standard level MOSFET

Min

Тур

	source-drain voltage	rce-drain voltage $I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}; \text{ see}$ Figure 17					1.2	V
	reverse recovery time	$I_{\rm S} = 50 \text{ A}; \text{ d}I_{\rm S}/\text{d}t = 100 \text{ A}$	/µs; V <sub>GS</sub> = 0 V;		-	52	-	ns
	recovered charge	V <sub>DS</sub> = 40 V			-	91	-	nC
6	50	003aad181	4000				003aad187	
6 I <sub>D</sub> (A)								
	50	5	C (pF)		-		C <sub>iss</sub>	
		5	3000	$\square$				
4	40							
Э	30		2000				C <sub>rss</sub>	
							U <sub>rss</sub>	
2	20	4.5						
			1000					
1	10							
		$V_{GS}(V) = 4_{$						
	0 0.5 1	1.5 V <sub>DS</sub> (V) 2	0	3	6	9	12	2
g 5.	$T_j = 25 ^{\circ}C$ Output characteristics: c function of drain-source	Irain current as a		$V_{DS} =$ and reversion of gate		fer cap		
	Output characteristics: of function of drain-source	Irain current as a voltage; typical values	functio	and revers	se trans	fer cap	acitance e; typica	
7	Output characteristics: c function of drain-source	Irain current as a	45	and revers	se trans	fer cap	acitance	
7	Output characteristics: c function of drain-source	Irain current as a voltage; typical values	45 R <sub>DSon</sub>	and revers	se trans	fer cap	acitance e; typica	
7	Output characteristics: c function of drain-source	Irain current as a voltage; typical values	45 R <sub>DSon</sub> (mΩ)	and revers	se trans	fer cap	acitance e; typica	
7 I <sub>D</sub> (A) 6	Output characteristics: c function of drain-source	Irain current as a voltage; typical values	45 R <sub>DSon</sub>	and revers	se trans	fer cap	acitance e; typica	
7 I <sub>D</sub> (A) 6	Output characteristics: c function of drain-source	Irain current as a voltage; typical values	45 R <sub>DSon</sub> (mΩ)	and revers	se trans	fer cap	acitance e; typica	
7 I <sub>D</sub> (A) 6	Output characteristics: c function of drain-source	Irain current as a voltage; typical values	45 R <sub>DSon</sub> (mΩ)	and revers	se trans	fer cap	acitance e; typica	
7 I <sub>D</sub> (A) 5 4	Output characteristics: c function of drain-source	Irain current as a voltage; typical values	45 R <sub>DSon</sub> (mΩ) 35	and revers	se trans	fer cap	acitance e; typica	
(A) (A) 5 4 3	Output characteristics: c           function of drain-source           0           50	Irain current as a voltage; typical values	45 R <sub>DSon</sub> (mΩ) 35	and revers	se trans	fer cap	acitance e; typica	
(A) (A) 5 4 3	Output characteristics: c function of drain-source	Irain current as a voltage; typical values	45 R <sub>DSon</sub> (mΩ) 35	and revers	se trans	fer cap	acitance e; typica	
7 (A) 5 4 3 2	Output characteristics: c           function of drain-source           0           50	003aad183	45 R <sub>DSon</sub> (mΩ) 35 25	and revers	se trans	fer cap	acitance e; typica	
م (A) (A) 5 4 3 2 1	Output characteristics: c function of drain-source	Irain current as a voltage; typical values	45 R <sub>DSon</sub> (mΩ) 35 25 15	and revers	se trans	fer cap	acitance e; typica	
م (A) (A) 5 4 3 2 1	Output characteristics: c function of drain-source	003aad183	45 R <sub>DSon</sub> (mΩ) 35 25	and revers	se trans	fer cap	acitance e; typica 003aad189	I value
م (A) (A) 5 4 3 2 1	Output characteristics: c function of drain-source	$\begin{array}{c} 003aad183\\ \hline \\ 003aad183\\ \hline \\ \hline \\ T_{j}=25\ ^{\circ}\text{C}\\ \hline \\ 4 \\ V_{GS}(V) \end{array}^{6} \end{array}$	function 45 R <sub>DSon</sub> (mΩ) 35 25 15 5	and reversion of gate	se trans -source	fer cap voltag	acitance e; typica 003aad189	I value
م (A) (A) 5 4 3 2 1	Output characteristics: c function of drain-source	$\begin{array}{c} 0.03aad183\\ \hline \\ 0.03aad183\\ \hline \\ \hline$	45 R <sub>DSon</sub> (mΩ) 35 25 15 5 0	and reversion of gate	se trans source	fer cap voltag	003aad189	)

### Table 6. Characteristics ...continued

Parameter

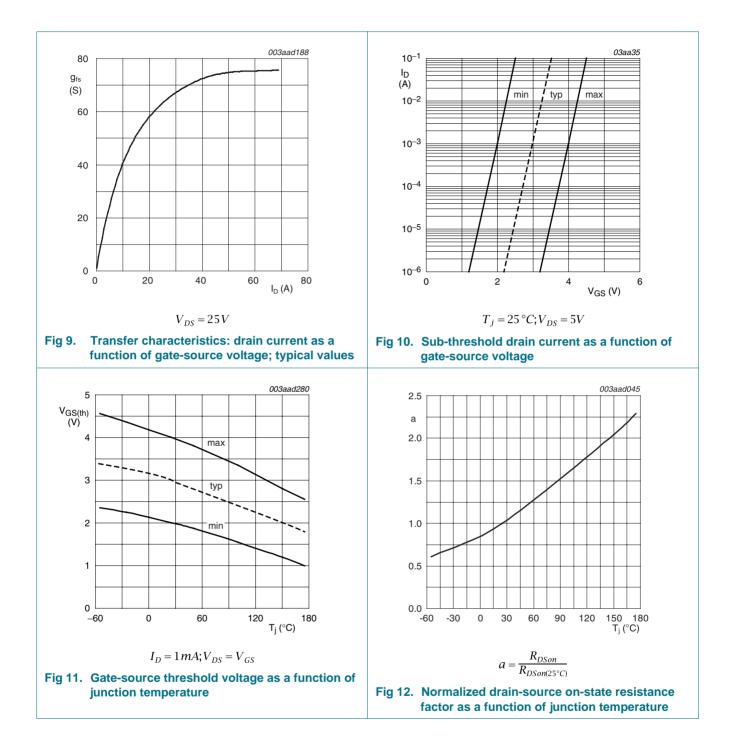
Tested to JEDEC standards where applicable.

Conditions

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# **PSMN013-80YS**

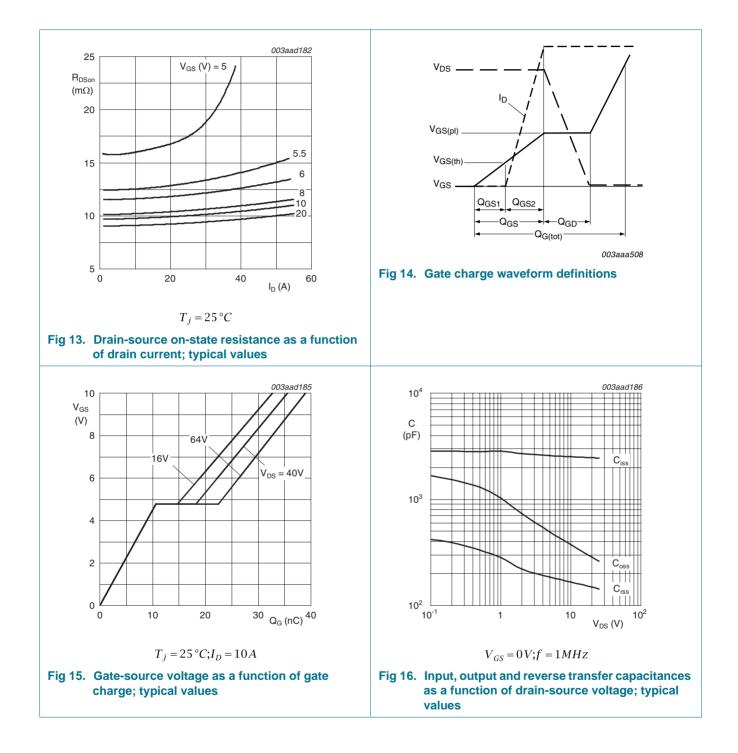
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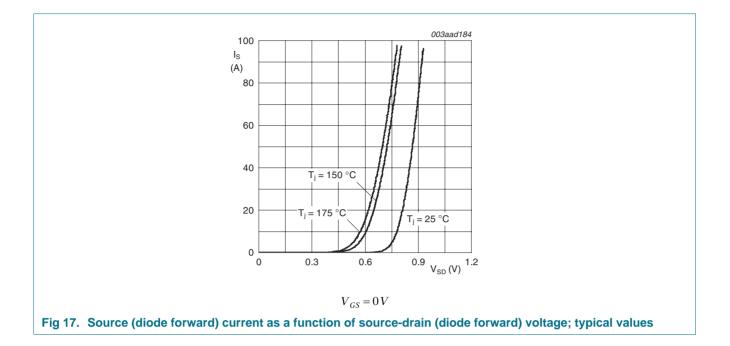
#### N-channel LFPAK 80 V 12.9 mΩ standard level MOSFET



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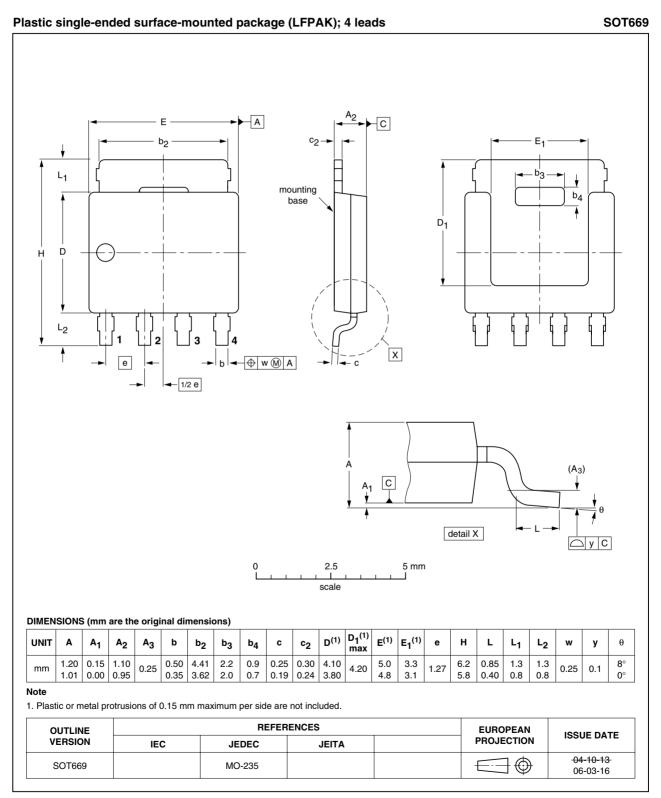
#### N-channel LFPAK 80 V 12.9 mΩ standard level MOSFET



# **PSMN013-80YS**

#### N-channel LFPAK 80 V 12.9 mΩ standard level MOSFET

# 7. Package outline



#### Fig 18. Package outline SOT669 (LFPAK)

PSMN013-80YS\_1

# 8. Revision history

Table 7. Revision hist	Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
PSMN013-80YS_1	20090625	Product data sheet	-	-		

# 9. Legal information

## 9.1 Data sheet status

Document status [1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

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